

SMALL SIGNAL SWITCHING DIODE

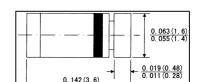
FEATURES

- . Silicon epitaxial planar diode
- . Fast swithching diodes
- . 500mW power dissipation
- . The diode is also available in the DO-35 case with the type designation 1N4448

MECHANICAL DATA

. Case: MinMelf glass case(SOD-80)

. Weight: Approx. 0.05gram



Mini-MELF

Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Ratings at 25°C ambient temperature unless otherwise specified)

Symbol	Value	Units
VR	75	Volts
VRM	100	Volts
lav	1501)	mA
IFSM	500	mW
Ptot	5001)	mW
TJ	175	${\mathbb C}$
Tstg	-65 to + 175	$^{\circ}$
	VR VRM IAV IFSM Ptot TJ	VR 75 VRM 100 IAV 1501) IFSM 500 Ptot 5001) TJ 175

ELECTRICAL CHARACTERISTICS

(Ratings at 25°C ambient temperature unless otherwise specified)

	Symbol	Min.	Тур.	Max.	Units
Forward voltage at IF=5mA	VF	0.62		0.72	V
at IF=10mA	VF			1	V
Leakage current at VR=20V	lR			25	nA
at VR=75V	lR			5	μΑ
at VR=20V, TJ=150℃	lR			50	μΑ
Junction capacitance at VR=VF=0V	Сл			4	pF
Reverse breakdown voltage tested with 100µA pluse	V(BR)R	100			V
Reverse recovery time from IF=10 \(\mu \)A to IR=1mA,	trr	ter		4	ns
VR=6V, RL=100 Ω		ui ui			
Thermal resistance junction to ambient	Rθ JA			3501)	K/W
Rectification efficience at f=100MHz,VRF=2V	η	0.45			
1)Valid provided that leads at a distance of 8mm from case are kept at ambient temperature(DO-35)					



RATINGS AND CHATACTERISTIC CURVES LL4448

FLG.1-FORWARD CHARACTERISTICS

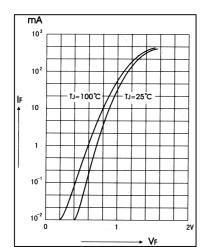


FIG.3-ADMISSIBLE POWER DISSIPATION VERSUS AMBIENT TEMPERATURE

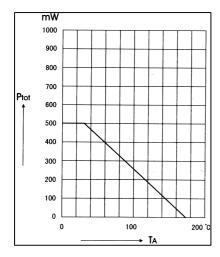


FIG.2-DYNAMIC FORWARD RESISTANCE VERSUS FORWARD CURRENT

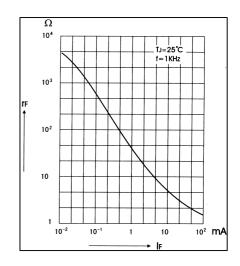
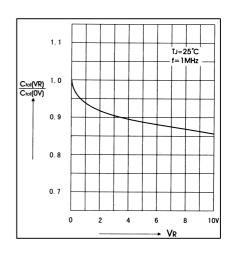


FIG.4-RELATIVE CAPACITANCE VERSUS VOLTAGE





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FIG.5-RECTIFICATION EFFICIENCY MEASUREMENT CIRCUIT

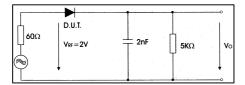


FIG.6-LEAKAGE CURRENT VERSUS JUNCTION TEMPERATURE

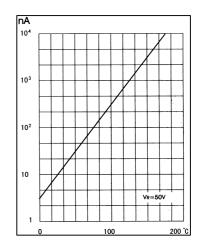


FIG.7-ADMISSIBLE REPETITIVE PEAK FORWARD CURRENT VERSUS PULSE DURATION

